

ULTRAFAST LASER WORKSTATIONS

3D MICROFABRICATION SERVICES



 **Femtika**

WWW.FEMTIKA.COM

ABOUT FEMTIKA

FEMTIKA is a leading provider of advanced laser technology solutions in selective laser etching, multiphoton polymerization and additional femtosecond-driven techniques. Our cutting-edge technology allows for precise and efficient processing in a wide range of industries, including microelectronics, medical devices, and semiconductor sector.

Founded in 2013, our team of experienced scientists and engineers has been at the forefront of laser technology research and development. Our commitment to innovation and excellence has led to the development of unique and highly effective laser solutions that deliver superior results.

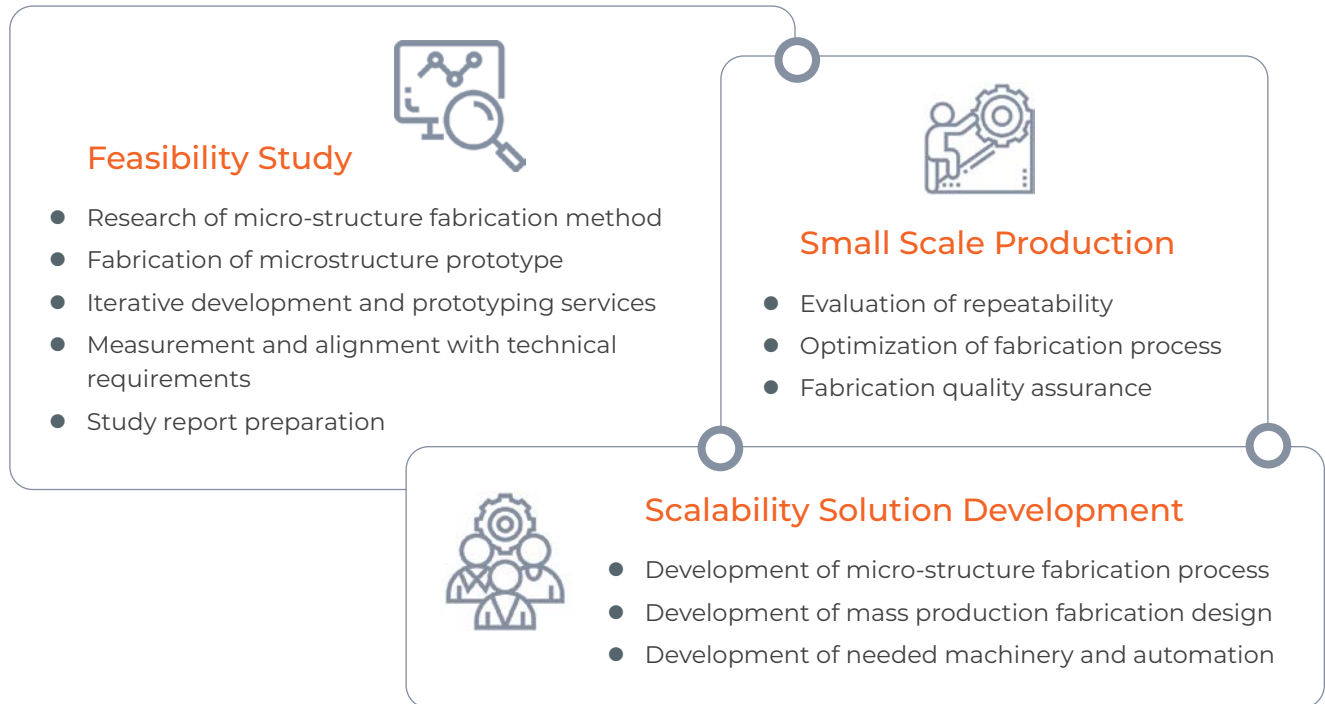
Our state-of-the-art facility is equipped with the latest equipment and technology, allowing us to provide our clients with the highest level of service and support. We also offer comprehensive training and technical support to ensure that our clients have the knowledge and tools they need to achieve their goals.

At FEMTIKA, we are dedicated to providing our clients with the best laser technology solutions available on the market. We strive to exceed our clients' expectations and help them achieve success in their industries.

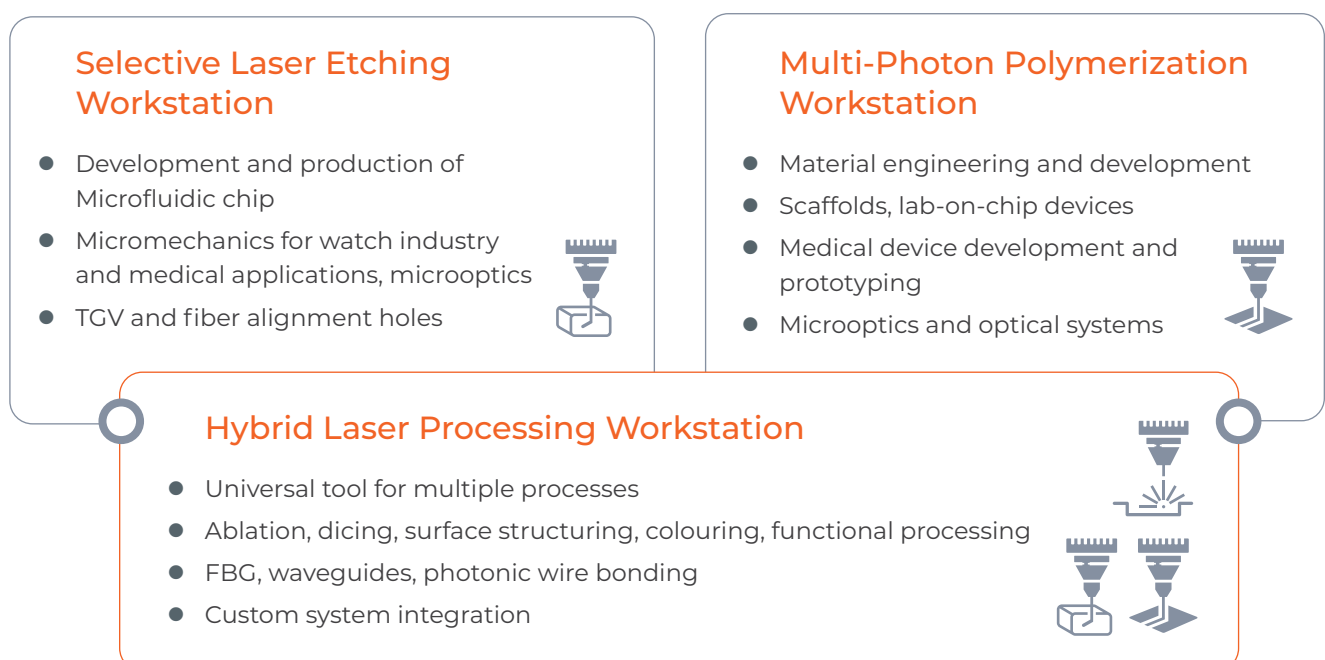
The company belongs to the European Photonics Industry Consortium (EPIC), the TOOLAS cluster, and the Lithuanian Laser Association.

FEMTIKA PRODUCTS & SERVICES

CONTRACT DEVELOPMENT AND MANUFACTURING SERVICES



ULTRAFAST LASER WORKSTATIONS – LASER NANOFACTORY SERIES





ULTRAFAST LASER
WORKSTATIONS

GLASS LASER WORKSTATION

A dedicated solution for your glass micro-processing tasks



FEATURES

- Dual-objective head for effortless fabrication mode transition
- Multi-scale glass processing: achieve precision from μm to cm scales
- Autofocus
- Self-aligning optical system for reduced maintenance requirements
- High-sensitivity camera for real-time process monitoring

PROCESS SPECIFICATIONS

- Technology: selective laser etching, ablation, welding, refractive index modification
- Materials: fused silica, borosilicate glass and other transparent materials
- Smallest feature size: $> 1 \mu\text{m}$
- Minimum surface roughness: $< 200 \text{ nm}$
- Maximum object height: 20 mm
- Aspect ratio: $> 1 : 200$
- Minimum micro hole diameter: $5 \mu\text{m}$

TECHNICAL SPECIFICATIONS

Femtosecond laser source	Wavelength	1030 \pm 10 nm		
	Max. average power	10 W		
	Pulse duration	400 fs – 4 ps		
	Repetition rate	100 kHz – 1 MHz		
	Max. pulse energy	$> 100 \mu\text{J}$		
Positioning stages (XYZ)	Axis	X	Y	Z
	Travel *	120 mm	120 mm	60 mm
	Accuracy	$\pm 0.5 \mu\text{m}$	$\pm 0.5 \mu\text{m}$	$\pm 0.5 \mu\text{m}$
	Bi-Directional Repeatability	$\pm 0.15 \mu\text{m}$	$\pm 0.15 \mu\text{m}$	$\pm 0.15 \mu\text{m}$
	Maximum speed (no load)	350 mm/s	350 mm/s	200 mm/s
Galvano scanners	Scan angle	$\pm 0.35 \text{ rad}$		
	Repeatability	0.4 μrad RMS		

* Custom travel range options: 160x160, 300x300, 600x600.

FBG WRITING WORKSTATION

A dedicated solution for writing fiber bragg grating



FEATURES

- Fiber core detection using camera or autofocus
- Fiber bragg grating (FBG) writing using PbP, LbL methods with an option for phase mask writing
- 4 core fiber writing
- Cladding removal via laser ablation
- Comprehensive laser control capabilities for the precise optimization of specialized tasks.
- Automation possibility with a roll-to-roll solution (also available with an imersive objective)

TECHNICAL SPECIFICATIONS

Femtosecond laser source	Wavelength	1030 ± 10 nm and 515 ± 10 nm		
	Max. average power	10 W		
	Pulse duration	250 fs – 10 ps (tunable)		
	Repetition rate	Single-shot – 1 MHz		
	Long-term power stability	< 0.5% RMS over 100 h		
Positioning stages (XYZ)	Axis	X	Y	Z
	Travel	150 mm	100 mm	60 mm
	Accuracy	± 200 nm	± 200 nm	± 275 nm
	Resolution	0.5 nm	0.5 nm	2 nm
	Maximum speed	350 mm/s	350 mm/s	200 mm/s

LASER NANOFABRICTION WORKSTATIONS

FEATURES

- Combine additive and subtractive manufacturing in one system
- Wide tunability enables efficient fabrication of micro-nano structures using a wide range of materials
- Stitching-error-free manufacturing
- User friendly, wizard-guided software for model preparation and system operation
- Modular and customizable system
- Integratable into production lines

TECHNICAL SPECIFICATIONS

Technology	Selective Laser Etching	Multiphoton Polymerization	Hybrid
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LASER SOURCE

Femtosecond laser	Wavelength	1030 ± 10 nm	780 ± 10 nm	1030 ± 10 nm and 515 ± 10 nm
	Repetition rate	Single-shot – 1 MHz	> 80 MHz	Single-shot – 1 MHz
	Pulse duration	250 fs (450 fs) – 10 ps (tunable)	< 150 fs	190 fs – 10 ps (tunable)
	Max. average power	5 W	> 250 mW	from 5 W to 20 W*
	Long-term power stability	< 0.5% RMS over 100 h	< 0.5% RMS over 24 h	< 0.5% RMS over 100 h

POSITIONING

Linear stages with synchronized Galvano scanners	XYZ POSITIONING STAGES MOUNTED ON GRANITE BASE WITH BRIDGE	
	Travel (XYZ)	160 mm × 160 mm × 60 mm *
	Accuracy (XYZ)	± 300 nm
	Resolution (XYZ)	1 nm
	Maximum speed (XY)	200 mm/s
	GALVANO SCANNERS	
	Accuracy	50 μrad
	Repeatability	0.4 μrad RMS

Technology	Selective Laser Etching	Multiphoton Polymerization	Hybrid
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OTHER PARAMETERS

Monitoring on time	The fabrication process is monitored by an integrated machine vision system		
Stitching	Stitchless fabrication using Infinite Field of View (IFoV)		
Focusing optics	Objectives – from 0.25 to 0.45 NA *	Objectives – from 0.4 to 1.4 NA *	Objectives – from 0.25 to 1.4 NA *
Autofocus system	Automatic glass/polymer or glass/air interface optical detection		
Self-Align-System (SAS)	Automatic laser beam path alignment system		
Substrate	Universal vacuum sample holder with computer-controlled, position synchronized illumination for transparent samples		
Beam delivery & control	Motorized attenuator, polarization rotator, beam expander. Integrated power meter enables real-time power monitoring		
Software	Convenient control of all necessary process parameters and machine settings. The software handles standard formats of 3D designs created by popular CAD programs, like STL		
Laser safety	Ergonomic housing to ensure laser safety class 1 and environment stability conditions for laser microfabrication process		

* Customizable.

PHYSICAL DIMENSIONS

Dimensions when all doors are closed (W × L × H)	1790 mm × 920 mm × 2270 mm
Dimensions when doors are opened (W × L × H)	2680 mm × 1900 mm × 2300 mm
Weight	870 kg

ENVIRONMENTAL & UTILITY REQUIREMENTS

Operating temperature	20 °C ± 2 °C
Relative humidity	≤ 60%
Electrical requirements	110 V AC, 20 A – 230 V AC , 10 A
AC power (normal operation)	typical 2 kW

The conditions of the environment are preferred to be as stable as possible.

CUSTOM LASER SYSTEM INTEGRATION

UNIVERSITY OF DUISBURG-ESSEN

Complex multi process Laser Workstation Integration, employing multiphoton polymerization, ink-jet printing, time resolved photoluminescence, Raman spectroscopy based diagnostics, laser processing in gas environment. All controlled by the Femtika software with semi-automatic switching between laser processes, work areas and modes. System used in academia for semiconductor solar cell prototyping and characterization.



MESOMORPH

EU funded Horizon-2020 project Mesomorph brought up together a dozen or partners for integration of atomic layer deposition, multi-photon polymerization, laser ablation, selective laser etching, and machine vision / diagnostics system into single machine for development and production of optoelectronic components.

<https://mesomorph-h2020project.eu/>



FEMTOSURF

The FemtoSurf Project has received funding from the European Union's Horizon 2020 Research and Innovation Program. The main objective of FemtoSurf project was to develop, test and demonstrate industrial-grade solid state 2-3 kW-level fs laser with parameters suitable for metal surface patterning applicable in industrial settings.

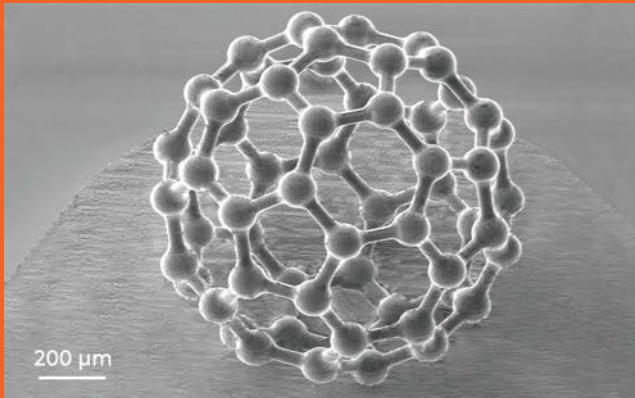
<https://www.femt surf.eu/>





CONTRACT DEVELOPMENT AND
MANUFACTURING SERVICES

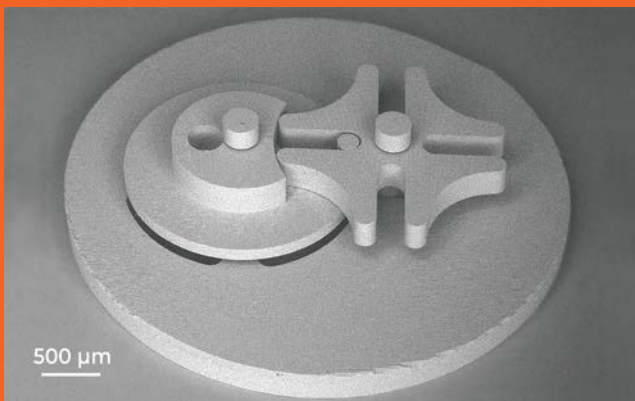
SELECTIVE LASER ETCHING



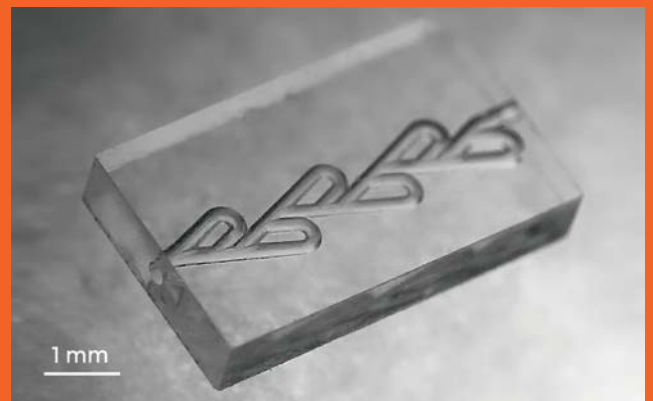
3D glass structures



3D nozzle



Geneva mechanism



Tesla valve



Microchannels



Fiber array

SELECTIVE LASER ETCHING



APPLICATIONS

- Micro-mechanics
- Micro-fluidics
- Lab-on-chip
- Microoptics

FEATURES

- Subtractive manufacturing technique
- Arbitrary-shaped 3D structures from glass μm to cm scale
- Various glasses applicable
- Self-alignment system for automatic laser beam alignment
- Micrometer feature resolution

Selective laser etching (SLE) is a subtractive laser technology allowing fabrication of complex-shape 3D glass parts with micrometer precision. This technology consists of two fabrications steps: femtosecond laser irradiation and subsequent chemical etching. Tightly focused the femtosecond laser beam induces modifications of transparent material within the focal point of laser beam. By spatially moving the laser focus well-defined structure is written in point-by-point fashion up to substrate surface. Afterward, the sample is immersed in etchant solution, which etches out laser modified areas.

SLE is often used in the manufacturing of electronic devices and other precision components ensuring high accuracy and detail in etched patterns. Moreover, the highly focused light enables the creation of complex 3D shapes and intricate designs.

SPECIFICATIONS

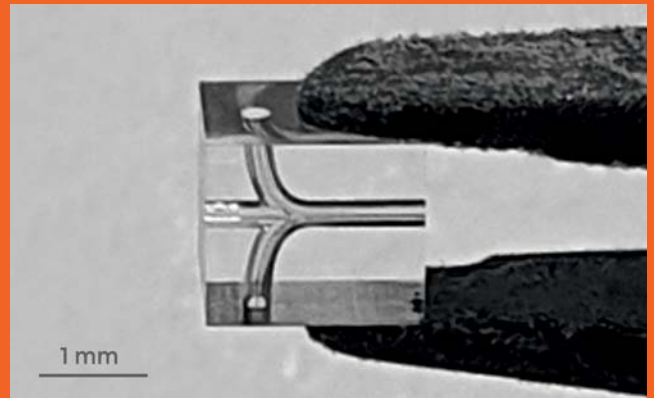
Technology	Subtractive manufacturing
Materials	Fused silica, borosilicate
Smallest feature size	$> 1 \mu\text{m}$
Minimum surface roughness	$50^* - 200 \text{ nm}$
Maximum object height	1 cm
Aspect ratio	$> 1 : 200$
Minimum micro hole diameter	$5 \mu\text{m}$
Writing speed	50 mm/s

* Applying additional polishing.

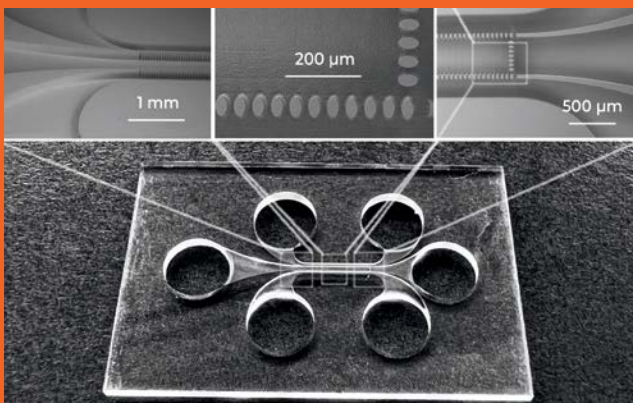
SELECTIVE LASER ETCHING



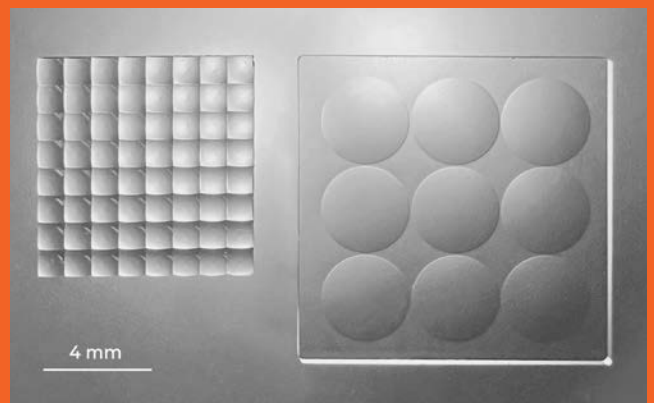
Gears system



3D interconnect channels



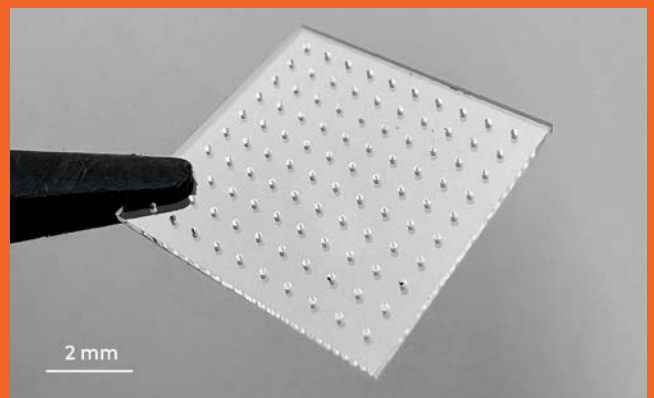
Microfluidics



Microoptics, microlenses



Threads for screw

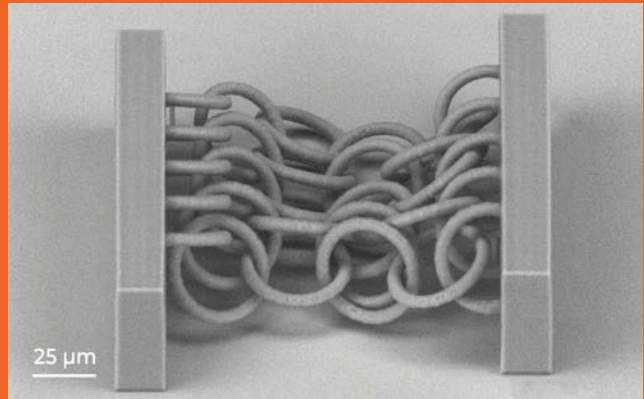


Quantum computing / TGV

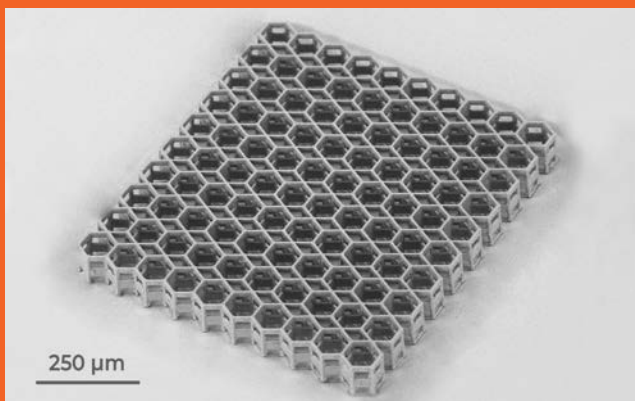
MULTIPHOTON POLYMERIZATION



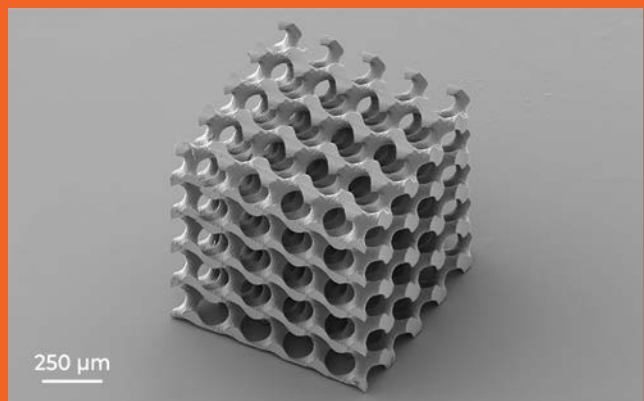
3D structures on fiber tip



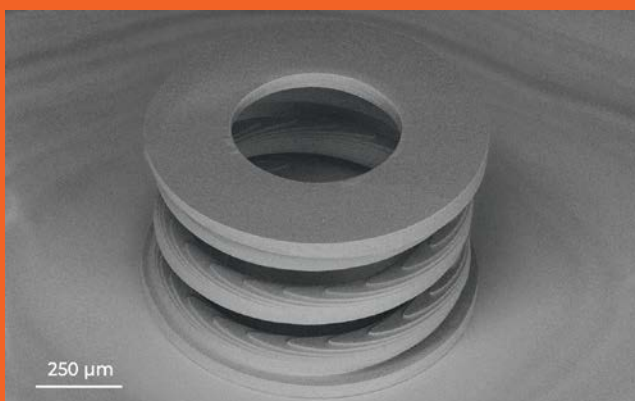
3D chain-mail structure



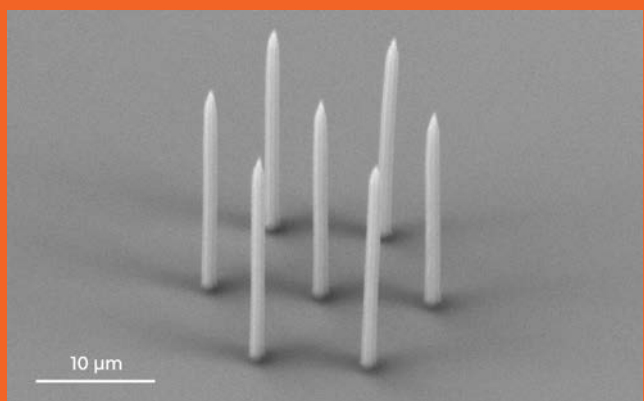
3D scaffold



3D gyroid structure



3D meso-spring

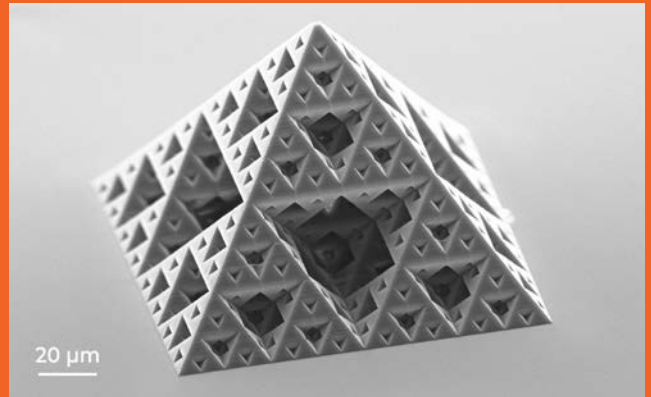


Microneedles

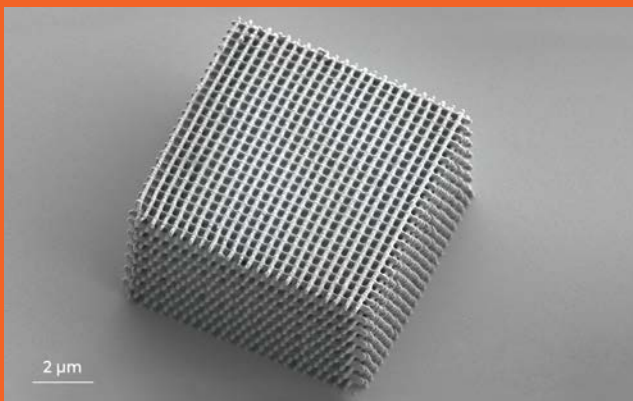
MULTIPHOTON POLYMERIZATION



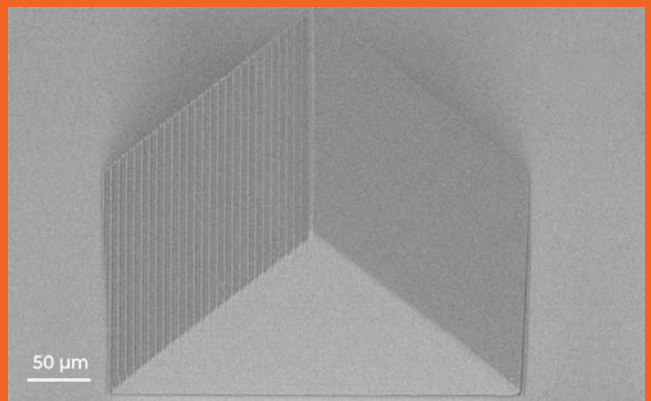
Mechanical bearing



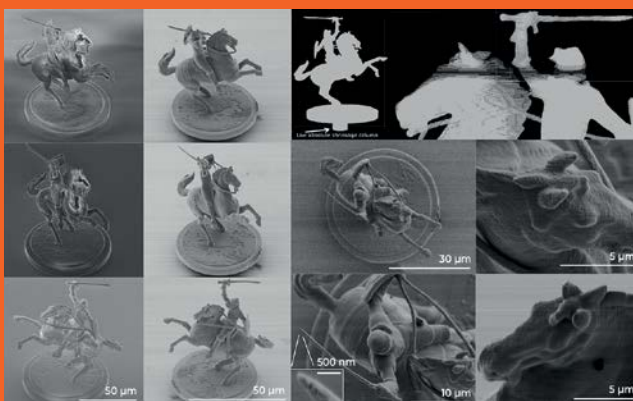
3D pyramid structure



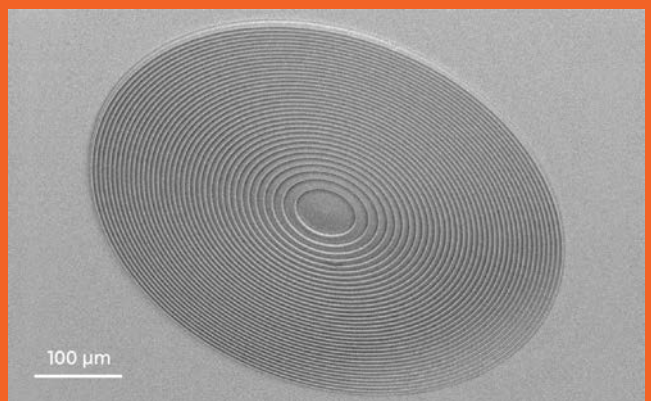
Photonic crystal



Prism for ellipsometry



Ceramic structures



Fresnel lens

MULTIPHOTON POLYMERIZATION



APPLICATIONS

- Micro-optics
- Micro-mechanics
- Scaffolds
- Sensors
- Interconnects

FEATURES

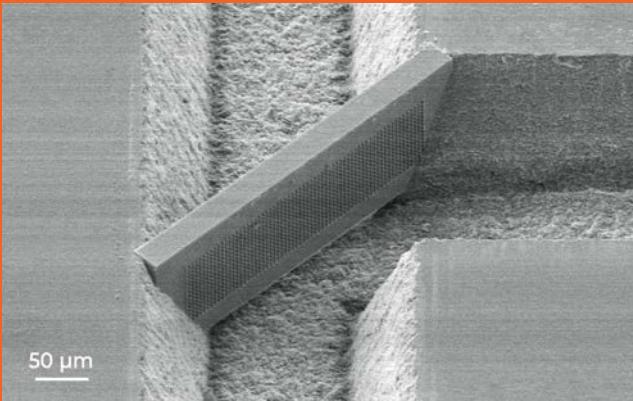
- Sub-micrometer resolution additive manufacturing technique
- True 3D structures in micrometer scale
- Various polymers available
- Stitching error-free manufacturing

Multiphoton polymerization (MPP) is a technology that enables the production of arbitrary shape polymeric structures within sub-micrometer resolution. First, a photoresist sample is prepared by drop-casting polymer material mixed with a photoinitiator on the glass slide and then pre-baking. Afterward, the 3D microstructure is fabricated using a direct laser writing technique. Consequently, the polymer hardens in places of drop where it is affected by laser radiation due to a process called photopolymerization. Finally, the microstructure is immersed in an organic solvent to develop an unpolymerized photoresist.

MPP is often used in the manufacturing of microelectronic devices, as it allows for the creation of very small and detailed structures with high levels of precision. Additionally, because the light is highly focused, it can be used to create complex 3D shapes.

SPECIFICATIONS

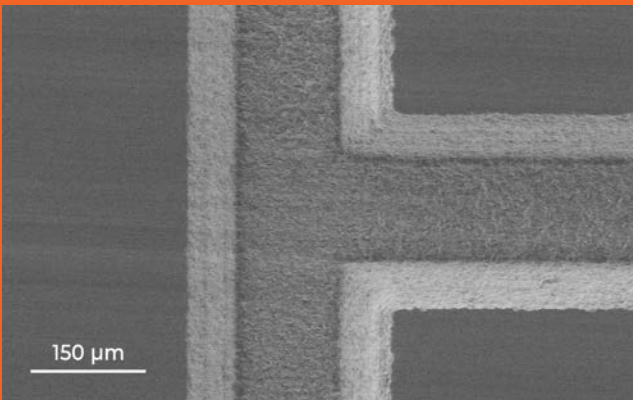
Technology	Additive manufacturing
Materials	Hybrid organic inorganic polymer, hydrogels, epoxy-based photoresist, elastomers, proteins, glassomers (SZ2080, Ormocers, PEG-DA, SU-8, PDMS and others)
Minimum XY feature size	150 nm
Minimum surface roughness Ra	≤ 20 nm
Maximum fabrication speed	30 mm/s



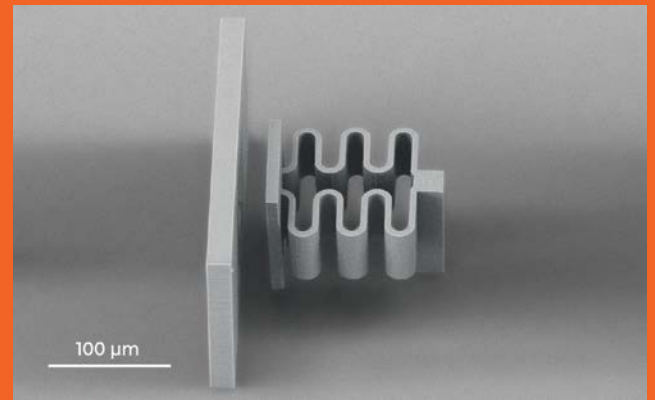
Lab-on-chip device



Liver-on-chip



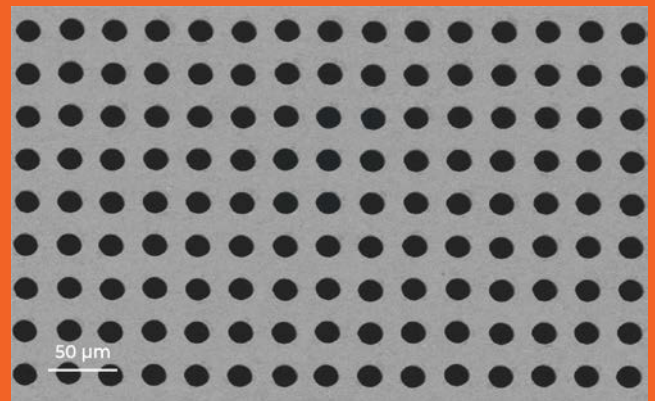
Lab-on-chip device



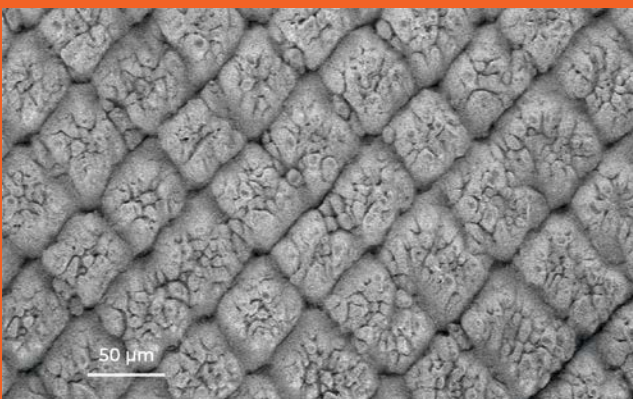
Micromechanical sensor



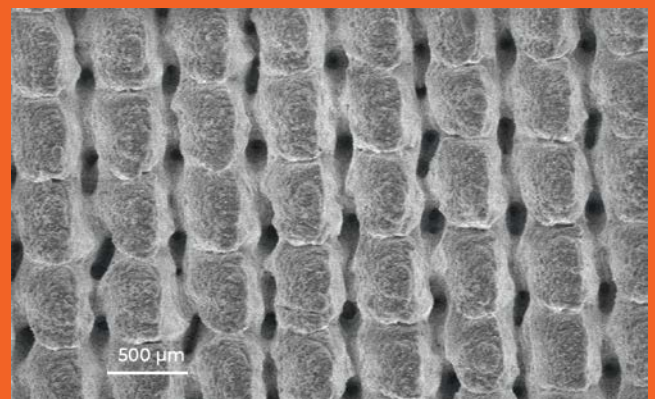
Laser surface texturing



Holes in hard metal



Hydrophobic surface



Hydrophilic surface

HYBRID FABRICATION



APPLICATIONS

- Micromechanics
- Lab-on-chip
- Microfluidics
- Sensors

FEATURES

- Additive and subtractive techniques combined in one Laser Nanofactory system
- Arbitrary-shaped 3D structures from micrometers to centimeters scale
- Fast switch from additive to subtractive microfabrication
- Customizable configuration – integrate additional devices

Femtosecond lasers are extremely versatile tools allowing a great variety of different microfabrication processes. Each process has its own requirements for laser, beam delivery or material parameters. Our Laser Nanofactory workstation allows **hybrid fabrication**, meaning that various processes are supported by the same equipment. The two of our most frequently used processes are multiphoton polymerization and selective glass etching, however, that is far from all! By precisely tuning its parameters the same machine is capable to perform more processes including:

- Refractive index modification of transparent materials
- Micro-ablation
- Surface structuring
- Micro-welding

In addition, Laser Nanofactory is a modular system, allowing further adaptation to your application. It supports various sample holders (e.g. for microscope slides, wafers, fibers) and different fabrication heads, optimized for your desired laser applications.

INDUSTRIES

BIOTECHNOLOGIES



Biomedical 3D manufacturing is an ever growing topic. Femtosecond laser-based 3D multiphoton polymerization is a superb tool for fabrication of micro-scaffolds with complex functional architectures, wide-scaled and out of any relevant material.

OPTICS AND PHOTONICS



Producing of photonic devices based on high-resolution (up to hundreds of nm) single features for applications in visible and IR part of the spectrum. Fabrication of microoptics of any desirable shape as the optimized surface geometries allow minimising aberrations or creating exotic light distributions, like, for instance, Bessel beams or optical vortexes.

MEDICINE



Objects with controllable feature sizes that can be smaller, bigger or at the cell size can be produced. This enables the production of next-generation medical devices, such as cell perforators and micro-robots. They combine extremely small size and unmatched functionality, paving the way for completely new outlook to medical device design and fabrication.

MICROFLUIDICS



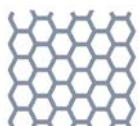
Amplified femtosecond lasers were shown to be extremely capable in producing microfluidical components. As they can be realized for both additive and subtractive manufacturing channels, arbitrary free form integrated elements and bonding can be realized with only one laser micromachining setup. This opens an array of new possibilities which can enrich this active research area with new set of capabilities.

MICROMECHANICS



3D femtosecond micro-manufacturing provides the steppingstone for downsizing mechanical elements down to sub-micrometer scale. What is more, due to diverse light-matter interaction regimes achievable with fs pulses it is possible to produce these elements from wide range of materials, starting with polymers and ending with glasses, dielectric crystals or metals. Gears, springs, cantilevers and other classical mechanical elements can be produced in micro-scale using this method.

SURFACE STRUCTURING



Functional surfaces are incredibly important in the fields ranging from medicine to space exploration. The surfaces created with fs pulses can be easily made both repelling and adhering, playing into needs of basically any application, including tool manufacturing, aviation, maritime and medicine.

PUBLICATION LIST

- [1] Butkutė, Agnė, et al. "Combined femtosecond laser glass microprocessing for liver-on-chip device fabrication." *Materials* 16.6 (2023): 2174.
- [2] Merkininkaitė, Greta, et al. "Additive manufacturing of SiOC, SiC, and Si₃N₄ ceramic 3D microstructures." *Advanced Engineering Materials* 25.17 (2023): 2300639.
- [3] Merkininkaitė, Greta, et al. "Laser additive manufacturing of Si/ZrO₂ tunable crystalline phase 3D nanostructures." *Opto-electronic advances*. 5.5 (2022): 1-11.
- [4] A. Butkutė, G. Merkininkaitė, T. Jurkšas, J. Stančikas, T. Baravykas, R. Vargalis, T. Tičkūnas, J. Bachmann, S. Šakirzanovas, V. Sirutkaitis, and L. Jonušauskas, "Femtosecond Laser Assisted 3D Etching Using Inorganic-Organic Etchant", *Materials* 2022,15, 2817, (2022).
- [5] G. Kontenis, D. Gailevičius, N. Jiménez, and K. Staliunas, "Optical Drills by Dynamic High-Order Bessel Beam Mixing", *Phys. Rev. Applied* 17, 034059, (2022).
- [6] D. Čereška, A. Žemaitis, G. Kontenis, G. Nemickas, and L. Jonušauskas, "On-Demand Wettability via Combining fs Laser Surface Structuring and Thermal Post-Treatment", *Materials* 2022,15, 2141, (2022).
- [7] A. Butkutė, and L. Jonušauskas, "3D Manufacturing of Glass Microstructures Using Femtosecond Laser", *Micromachines* 2021,12, 499, (2021).
- [8] D. Andrijec, D. Andriukaitis, R. Vargalis, T. Baravykas, T. Drevinskas, O. Kornysheva, A. Butkutė, V. Kaškonienė, M. Stankevičius, H. Gričius, A. Jagelavičius, A. Maruška, and L. Jonušauskas, "Hybrid additive subtractive femtosecond 3D manufacturing of nanofilter based microfluidic separator", *Applied Physics A* (2021).
- [9] D. Gonzalez-Hernandez, S. Varapnickas, G. Merkininkaitė, A. Čiburyš, D. Gailevičius, S. Šakirzanovas, S. Juodkazis, and M. Malinauskas, "Laser 3D Printing of Inorganic Free-Form Micro-Optics", *Photonics* 2021,8, 577, (2021).
- [10] D. Andriukaitis, A. Butkutė, T. Baravykas, R. Vargalis, J. Stančikas, T. Tičkūnas, V. Sirutkaitis, and L. Jonušauskas, "Femtosecond Fabrication of 3D Free-Form Functional Glass Microdevices: Burst-Mode Ablation and Selective Etching Solutions", 2021 Conference on Lasers and Electro-Optics Europe & European Quantum Electronics Conference, (2021).
- [11] A. Butkutė, T. Baravykas, J. Stančikas, T. Tičkūnas, R. Vargalis, D. Paipulas, V. Sirutkaitis, and L. Jonušauskas, "Optimization of selective laser etching (SLE) for glass micromechanical structure fabrication", *Optical Express* 23487, Vol. 29, No. 15, 19.07.2021, (2021).
- [12] A. Maruška, T. Drevinskas, M. Stankevičius, K. Bimbraitė-Survilienė, V. Kaškonienė, L. Jonušauskas, R. Gadonas, S. Nilsson, and O. Kornysheva, "Single-chip based contactless conductivity detection system for multi-channel separations", *Anal. Methods*, 2021,13,141-146, (2021).
- [13] L. Bakhchova, L. Jonušauskas, D. Andrijec, M. Kurachkina, T. Baravykas, A. Eremin, and U. Steinmann, "Femtosecond Laser-Based Integration of Nano-Membranes into Organ-on-a-Chip Systems", *Materials* 2020, 13, 3076 (2020).
- [14] T. Tičkūnas, D. Paipulas, and V. Purlys, "Dynamic voxel size tuning for direct laser writing," *Opt. Mater. Express* 10, 1432-1439 (2020).
- [15] T. Tičkūnas, D. Paipulas, and V. Purlys, "4Pi multiphoton polymerization", *Appl. Phys. Lett.* 116, 031101 (2020).

- [16] L. Jonušauskas, T. Baravykas, D. Andrijev, T. Gadišauskas, and V. Purlys, “Stitchless support-free 3D printing of free-form micromechanical structures with feature size on-demand”, *Sci Rep* 9, 17533 (2019).
- [17] S. Gawali, D. Gailevičius, G. Garre-Werner, V. Purlys, C. Cojocar, J. Trull, J. Montiel-Ponsoda, and K. Staliūnas, “Photonic crystal spatial filtering in broad aperture diode laser”, *Appl. Phys. Lett.* 115, 141104 (2019).
- [18] L. Jonušauskas, D. Gailevičius, S. Rekštytė, T. Baldacchini, S. Juodkakis, and M. Malinauskas, “Mesoscale laser 3D printing,” *Opt. Express* 27, 15205-15221 (2019).
- [19] L. Jonušauskas, D. Mackevičiūtė, G. Kontenis and V. Purlys, “Femtosecond lasers: the ultimate tool for high precision 3D manufacturing”, *Adv. Opt. Technol.*, 20190012, ISSN (Online) 2192-8584, (2019).
- [20] L. Grineviciute, C. Babayigit, D. Gailevicius, E. Bor, M. Turdnev, V. Purlys, T. Tolenis, H. Kurt, and K. Staliūnas, “Angular filtering by Bragg photonic microstructures fabricated by physical vapour deposition”, *Appl. Surf. Sci.*, 481, 353-359 (2019).
- [21] D. Gailevičius, V. Padolskytė, L. Mikoliūnaitė, S. Šakirzanovas, S. Juodkakis, and M. Malinauskas, “Additive manufacturing of 3D glass-ceramics down to nanoscale resolution”, *Nanoscale Horiz.*, 4, 647-651 (2019).
- [22] E. Yulanto, S. Chatterjee, V. Purlys, and V. Mizeikis, “Imaging of latent three-dimensional exposure patterns created by direct laser writing in photoresists”, *Appl. Surf. Sci.*, 479, 822-827 (2019).
- [23] L. Jonušauskas, S. Juodkakis, and M. Malinauskas, “Optical 3D printing: bridging the gaps in the mesoscale”, *J. Opt.*, 20(05301) (2018).
- [24] E. Skliutas, S. Kasetaitė, L. Jonušauskas, J. Ostrauskaitė, and M. Malinauskas “Photosensitive naturally derived resins toward optical 3-D printing,” *Opt. Eng.* 57(4), 041412 (2018).
- [25] L. Jonušauskas, S. Rekštytė, R. Buividas, S. Butkus, R. Gadonas, S. Juodkakis, and M. Malinauskas, “Hybrid subtractive-additive-welding microfabrication for lab-on-chip applications via single amplified femtosecond laser source,” *Opt. Eng.* 56(9), 094108 (2017).



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